

Southern Ohio Youth Regents STEM & Foreign Language Academy

FINANCIAL AID / FEE WAIVER FORM

Students who qualify to receive free or reduced-cost school lunch, students who are eligible to receive public assistance, students whose legal guardians are eligible to receive public assistance, **or who are experiencing financial hardship** are eligible to request a waiver of the mandatory deposit to attend the STEM Academy as a residential student.

To be completed by host college or university:

Name of College/university: Shawnee State University	Name of Program: STEM & Foreign Language Academy	Program Dates: June 13 – July 2, 2010
Contact Name: Judy Meeker	Telephone: 740.351.3411	Form Due Date: May 24, 2010
Institute Mailing Address: 940 Second Street, Portsmouth, OH 45662 or FAX to 740.351.3598		

To be completed by applicant:

<u>Student's Name (Print):</u>	<u>Student's 2009-2010 Grade Level:</u>
<u>2009-2010 School Building:</u>	<u>2009-2010 School District:</u>
<u>Home Telephone (Including Area Code):</u>	<u>County:</u>
<p>Eligibility: Please check all that apply.</p> <ul style="list-style-type: none"> <input type="checkbox"/> I am eligible for free or reduced-cost school lunch <input type="checkbox"/> I am eligible to receive public assistance (e.g. food stamps, subsidized housing, etc.) <input type="checkbox"/> My parent(s) or legal guardian(s) is eligible to receive public assistance <input type="checkbox"/> My family is experiencing financial hardship. A letter explaining the situation is attached to this application. <p><i>Attach to this form a copy of a document demonstrating eligibility for the above program(s), such as a letter from a school official, a copy of a document bearing the name of the parent or student from a public assistance program or agency (e.g. USDA/WIC, HUD, etc.) or an official letter from a public assistance agency verifying eligibility status.</i></p>	
<u>Student Signature:</u>	<u>Date:</u>
<u>Parent/Guardian Name (Print):</u>	<u>Parent/Guardian Signature:</u>
	<u>Date:</u>

Please return this form with your program application materials no later than May 24, 2010